

CoolMOS™ S7A

600V CoolMOS™ SJ S7A Power Device

IPQC60R010S7A is a high voltage power MOSFET, designed as static switch according to the superjunction (SJ) principle pioneered by Infineon Technologies.

IPQC60R010S7A combines the experience of the leading SJ MOSFET supplier with high class innovation enabling low R_{DS(on)} in QDPAK package. The S7A series is optimised for low frequency switching and high current application like circuit breakers.

Features

- Optimized for low switching frequency in high-end applications (circuit breakers and diode paralleling/replacement in bridge rectifiers).
- S7A technology enables best in class R_{DS(on)} in smallest footprint.
- Kelvin Source pin improves switching performance at high current.
- QDPAK (PG-HDSOP-22-1) package is MSL1 compliant, total Pb-free, has easy visual inspection leads.

Benefits

- S7A enabling low R_{DS(on)} for high constant current.
- Increased performance by using MOSFET instead of diode in the application (e.g. synchronous rectification).
- S7A can reach 10mΩ in ODPAK 315mm² footprint.
- Reduced parasitic source inductance by Kelvin Source improves stability for extreme high current handling and ease of use due to less
- Improved thermals enable SMD QDPAK package to be used in high current designs.

Potential applications

Circuit breakers (HV Battery disconnect switch, DC and AC low frequency switch, HV E-fuse) and diode paralleling/replacement for high power /performance applications.

Product validation

Qualified according to AEC Q101

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate. For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.

Table 1 **Kev Performance Parameters**

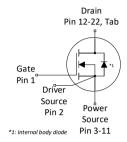
Parameter	Value	Unit
R _{DS(on),max}	10	mΩ
$Q_{g,typ}$	318	nC
V _{SD}	0.82	V
Pulsed I _{SD} , I _{DS}	801	A

Type/Ordering Code	Package	Marking	Related Links
IPDQ60R010S7A	PG-HDSOP-22	60A010S7	see Appendix A



PG-HDSOP-22







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600V CoolMOS™ SJ S7A Power Device IPDQ60R010S7A



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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Cumchal		Values			Note/Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/ Test Condition	
Drain current rating	I _D	-	-	50	А	T _C =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability	
Pulsed drain current 1)	I _{D,pulse}	-	-	801	А	T _c =25°C	
Avalanche energy, single pulse	E_{AS}	-	-	616	mJ	I _D =6.3A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	6.3	А	-	
MOSFET dv/dt ruggedness ²⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V	
Gate source voltage (static)	V_{GS}	-20	-	20	V	static	
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P_{tot}	-	-	694	W	T _C =25°C	
Storage temperature	$T_{\rm stg}$	-55	-	150	°C	-	
Operating junction temperature	$T_{\rm j}$	-40	-	150	°C	-	
Extended operating junction temperature	$T_{\rm j}$	150	_	175	°C	≤50 h in the application lifetime	
Mounting torque	-	-	-	n.a.	Ncm	-	
Diode forward current rating	Is	-	-	50	А	T _c =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability	
Diode pulse current ¹⁾	I _{S,pulse}	-	-	801	А	T _c =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <50A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	1000	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ ≤50A, $T_{\rm j}$ =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	٧	V _{rms} , T _C =25°C, <i>t</i> =1min	

 $^{^{1)}}$ Pulse width t_p limited by $T_{j,max}$

 $^{^{2)}\,\,}$ The dv/dt has to be limited by appropriate gate resistor

³⁾ Identical low side and high side switch



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Syllibol	Min.	Тур.	Мах.	Offic	Note/ Test Condition	
Thermal resistance, junction - case	R_{thJC}	-	-	0.18	°C/W	-	
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	device on PCB, minimal footprint	
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	45	55	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µ""m thickness) copper area. Tap exposed to air. PCB is vertical without air stream cooling.	
Soldering temperature, reflow soldering allowed	$T_{\rm sold}$	-	-	260	°C	reflow MSL1	



3 Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 Static characteristics

The CoolMOS™ mentioned in this datasheet shall not be operated in linear mode.

For any questions in this regard, please contact Infineon sales office.

For applications with applied blocking voltage >70% of the specified blocking voltage, it is required that the customer

evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Daramatar	Cymphol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	600	-	-	V	$V_{\rm GS}$ =0V, $I_{\rm D}$ =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 3.08 \rm mA$	
Zero gate voltage drain current	I _{DSS}	-	- 80	8 -	μΑ	$V_{\rm DS}$ =600V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C $V_{\rm DS}$ =600V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =150°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	I-	0.009 0.022	0.010	Ω	$V_{\rm GS}$ =12V, $I_{\rm D}$ =50A, $T_{\rm j}$ =25°C $V_{\rm GS}$ =12V, $I_{\rm D}$ =50A, $T_{\rm j}$ =150°C	
Gate resistance	R_{G}	-	0.45	-	Ω	<i>f</i> =1MHz, open drain	

Table 5 Dynamic characteristics

Devementer	Cymphol		Values		l lmit	Note/ Test Condition	
Parameter	Symbol	Min.	Тур.	Мах.	Unit		
Input capacitance	C _{iss}	-	11986	-	pF	V _{GS} =0V, V _{DS} =300V, <i>f</i> =250kHz	
Output capacitance	C_{oss}	-	188	-	pF	V _{GS} =0V, V _{DS} =300V, <i>f</i> =250kHz	
Effective output capacitance, energy related ⁴⁾	$C_{\rm o(er)}$	-	644	-	pF	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 300V	
Effective output capacitance, time related ⁵⁾	$C_{\rm o(tr)}$	-	5717	-	pF	$I_{\rm D}$ =constant, $V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 300V	
Output charge	Q _{oss}	-	1714	-	nC	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 300V	
Turn-on delay time	$t_{\sf d(on)}$	-	50	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Rise time	t_{r}	-	5	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Turn-off delay time	$t_{\sf d(off)}$	-	180	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Fall time	$t_{\scriptscriptstyle \mathrm{f}}$	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	

⁴⁾ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 300V

 $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 300V



Table 6 Gate charge characteristics

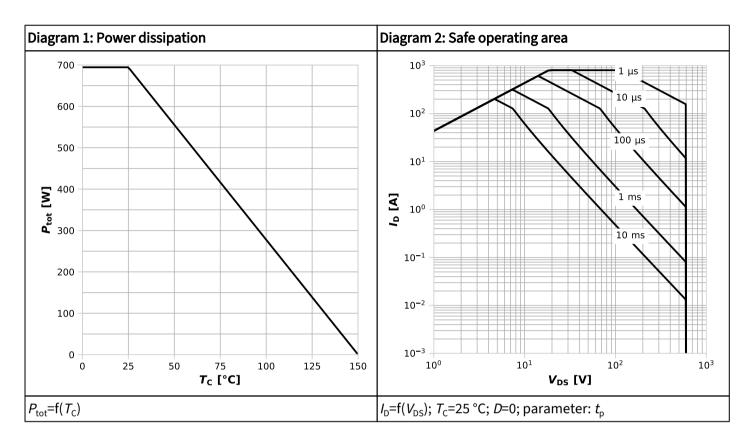
Parameter	Symbol	Values			l lmit	Note / Test Condition
	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Gate to source charge	$Q_{ m gs}$	-	69	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate to drain charge	$Q_{ m gd}$	-	105	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate charge total	$Q_{ m g}$	-	318	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V

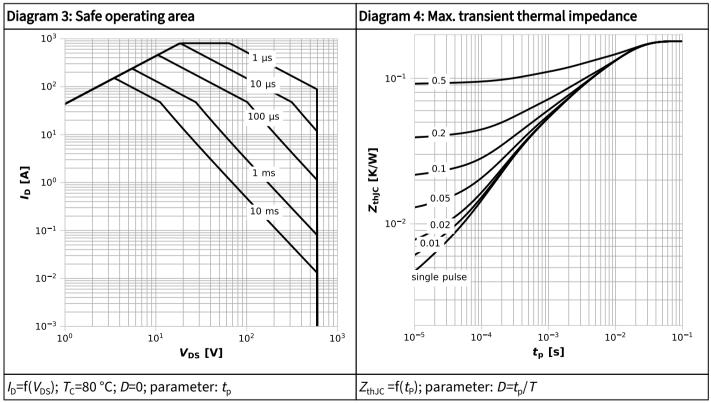
Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.		Note/ Test Condition	
Diode forward voltage	$V_{\rm SD}$	-	0.82	-	V	$V_{\rm GS}$ =0V, $I_{\rm F}$ =50A, $T_{\rm j}$ =25°C	
Reverse recovery time	t _{rr}	-	600	-	ns	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	
Reverse recovery charge	$Q_{\rm rr}$	-	17	-	μC	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $I_{\rm F}$ /d t =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	55	-	А	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $I_{\rm F}$ /d t =100A/ μ s; see table 8	

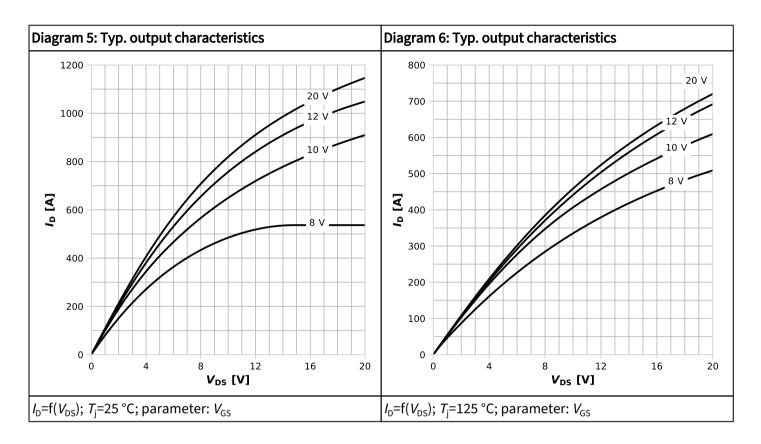


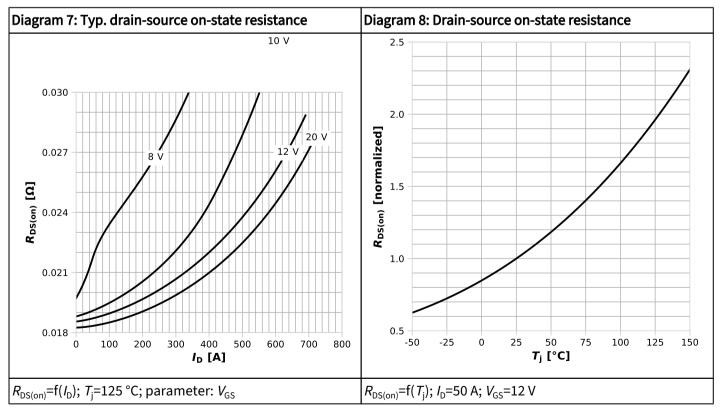
4 Electrical characteristics diagrams



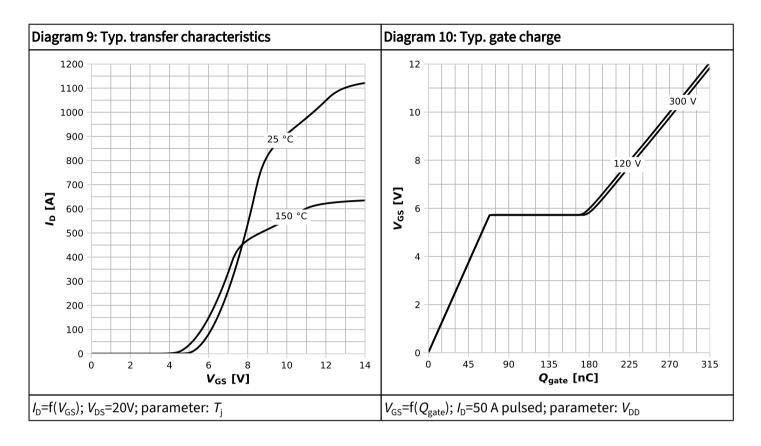


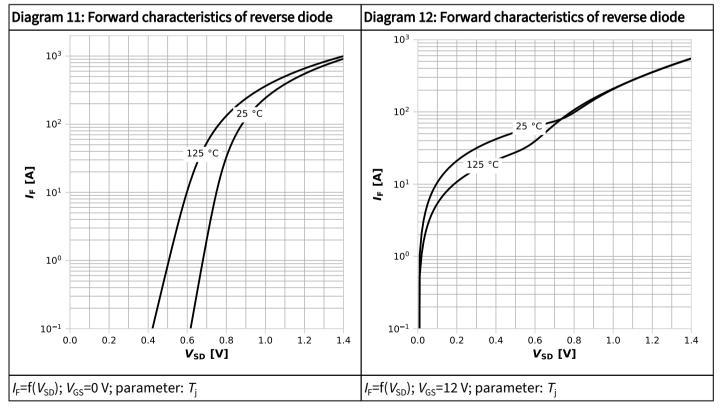




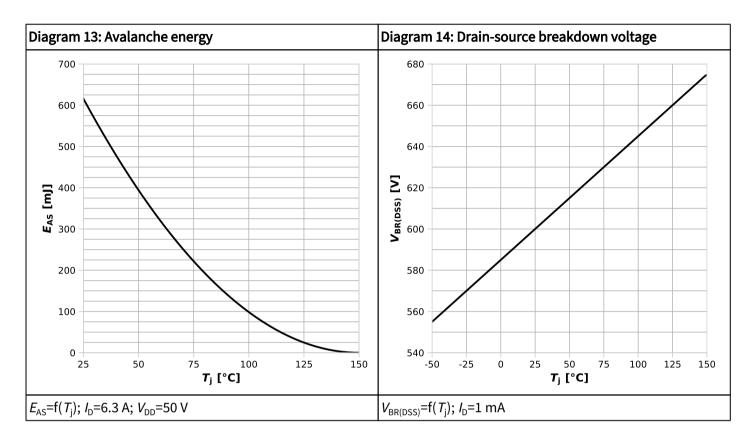


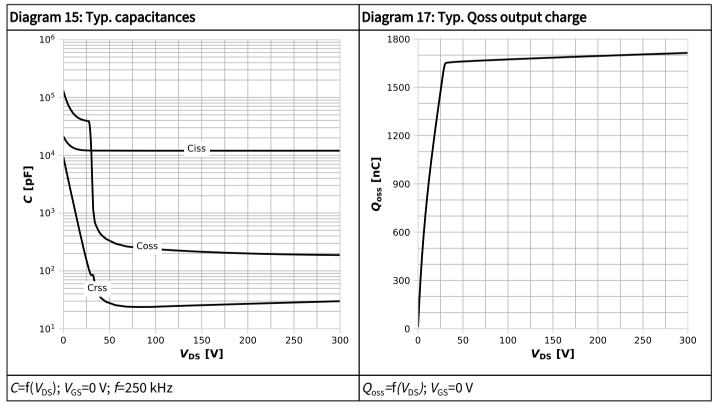














5 Test Circuits

Table 8 Diode characteristics

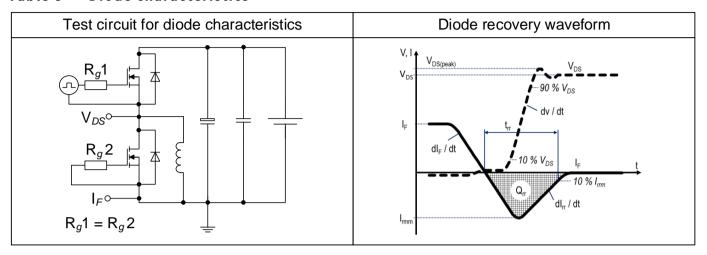


Table 9 Switching times (ss)

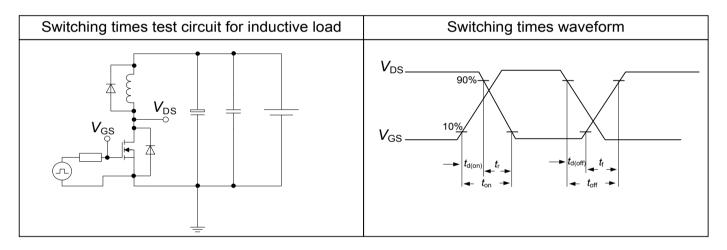
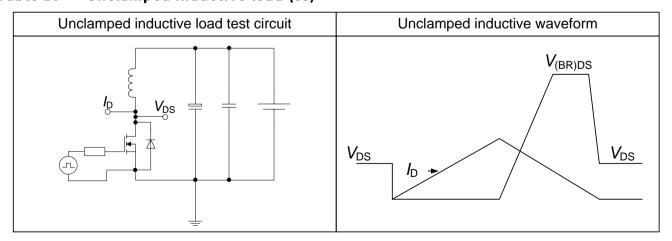


Table 10 Unclamped inductive load (ss)





6 Package Outlines

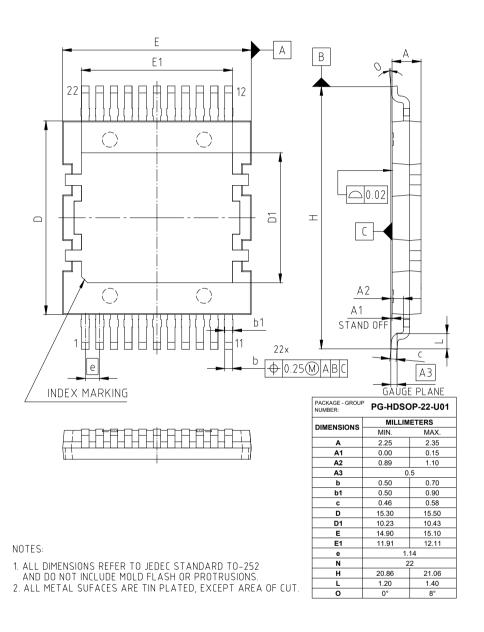


Figure 1 Outline PG-HDSOP-22, dimensions in mm



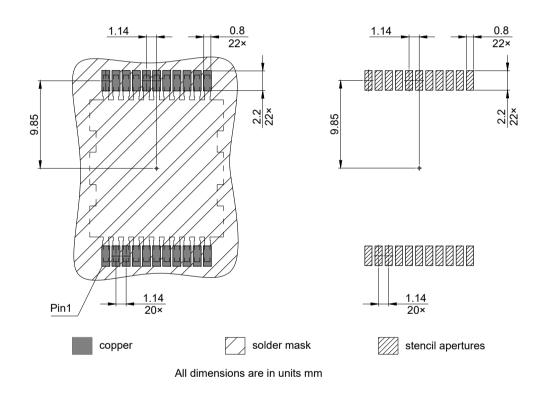


Figure 2 Outline PG-HDSOP-22, dimensions in mm



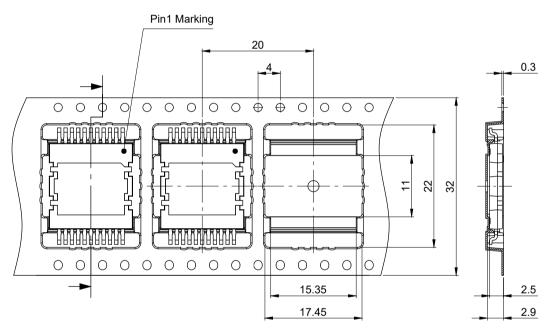


Figure 3 Outline PG-HDSOP-22, dimensions in mm



7 Appendix A

Table 11 Related Links

- IFX CoolMOS S7 Webpage
- IFX CoolMOS S7 application note
- IFX CoolMOS S7 simulation model
- IFX Design tools



Revision History

IPDO60R010S7A

Revision 2024-05-24, Rev. 2.4

Previous Revision

Previous	I CVISIOII	
Revision	Date	Subjects (major changes since last revision)
2.0	2020-07-02	Release of final version
2.1	2021-08-20	Added extended operation temperature of 175°C for 50h, Change of wording regarding breakdown voltage / cosmic ray
2.2	2023-10-27	Added footmark for pulsed drain current
2.3	2023-11-22	Additional maximum parameter for high current turn off added to datasheet for SSCB, SSR and motor start applications; Removed footmark from pulsed drain current
2.4	2024-05-24	Removed high current turn-off parameter limitation, Adaption of Transfer curve, Output characteristics and drain-source on-state resistance

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